Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yu-Pin Chou	09/13/2007

RECEIVING PARTY DATA

Name:	Realtek Semiconductor Corp.	
Street Address:	2 Innovation Rd. II, Science Park	
City:	HsinChu	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11863286

CORRESPONDENCE DATA

Fax Number: (703)997-4517

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3027291562

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU
Address Line 1: P.O.BOX 506

Address Line 4: Merrifield, VIRGINIA 22116

ATTORNEY DOCKET NUMBER: REAP0321USA

NAME OF SUBMITTER: WINSTON HSU

Total Attachments: 2

source=REAP0321USA0_A1_1_NP005#page1.tif source=REAP0321USA0_A1_1_NP005#page2.tif

PATENT REEL: 019893 FRAME: 0279

500364396

H \$40.00

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGN	OR(S) (Inventors):			
Name	e: Yu-Pin Chou	Nationality: R.O.C.		
Hereby sell	s, assigns and transfers to			
ASSIGNE	E(S):			
Name	e: Realtek Semiconductor C	Realtek Semiconductor Corp.		
Addr	ess: 2 Innovation Rd. II, Scien	2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.		
	ccessors and assignees of the a improvements which are discl	ASSIGNEE the entire right, title, and interest in and to osed in the invention entitled:		
" IM	PEDANCE MATCHING CIRCUI	T AND RELATED METHOD THEREOF"		
Which is	found in:			
(a)	U.S. patent application exe	ecuted on even date		
(b)	U.S. patent application exc	ecuted on		
(d)	patent no.	issued		

MATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Latters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will pastify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hercunto set hand and seal this EP 13 2007 (pate of signing). (请登明人杨必要是上列目期 ·)

(Type name of inventor)

Signature of INVENTOR

Yu-Pin Chou

Assignment, Page 2 of 2

P#NPO-P0002E-W31 DSB0-096U00008

NPO#REA-P0321-USA:0 CUST#94A-115

> PATENT REEL: 019893 FRAME: 0281